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Document Number : 0604-77
 Revision : A16
 Total Pages : 12
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 Date : 19 April, 2017

SoniCrest Brand Acoustic Components

www.jlsonicrest.com

Document Type : Specification
 Product Type : Silicon Microphone Component
 Part Number : SMO01A-42

A7 - Updated new part number by Ting Lok, Ngan on 19 Apr, 2007	A11 - Updated format and layout by Ting Lok, Ngan on 15 Jul., 2010	A15 - Updated section 5 - 7, 9 - 11 by Loki, Lo on 4 May, 2016
A8 - Updated section 11 by Ting Lok, Ngan on 6 Jun., 2007	A12 - Updated format and layout by Ting Lok, Ngan on 17 Jan., 2011	A16 - Updated section 2, 5 and 11 by Loki, Lo on 19 Apr., 2017
A9 - Updated section 10, 11 by Ting Lok, Ngan on 11 Mar., 2008	A13 - Updated section 6 by Holmes, Poon on 9 May, 2011	
A10 - Updated section 5, 7 and 11 by Holmes, Poon on 24 Nov., 2008	A14 - Updated format and layout by Ting Lok, Ngan on 9 Apr., 2013	

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1. Purpose and Scope

This document contains both general requirements, qualification requirements, and those specific electrical, mechanical requirements for this part.

2. Description

4.5 x 4.5 x 1.45 mm analog silicon microphone with N1 Sensor and C1 ASIC, top mounted, RoHS compliant.

3. Application

Smartphones, Wearables, Smart home devices, Video cameras, IoT devices, Automotive, Audio Input Peripherals, etc.

4. Features

- High Performance Analog ultra low pressure sensor
- Temperature Coefficient of Sensitivity stability within +/- 0.60 dB/Deg C.
- Pressure Coefficient of Stability within +/- 0.55 dB/Kpa
- Ultra Low Profile Package Availability
- Surface Mountable: MLP Design
- Tape & Reel Packaging
- RoHS Compliance

5. Interface Circuit Design Considerations

5.1. Design Consideration

- 5.1.1.** Must avoid connecting 2.2K resistor between VDD and output terminal will result in non-functional failure or current consumption will be too high.

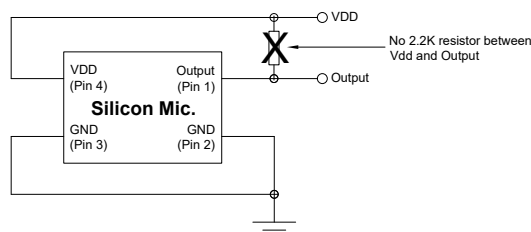


Figure 1. Design Consideration (1)

- 5.1.2.** Must avoid connecting RC to pin 2 because SoniCrest silicon microphones are all fixed gain series. Connecting RC to pin 2 leads to pin 2 floating resulted in malfunctioning or non-functional.

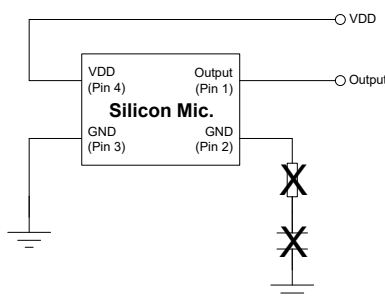


Figure 2. Design Consideration (2)

5.1.3. Interface Schematic

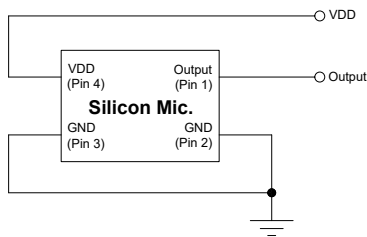


Figure 3. SMO01A-42 Interface Schematic Diagram

5.2. Electrical Layout

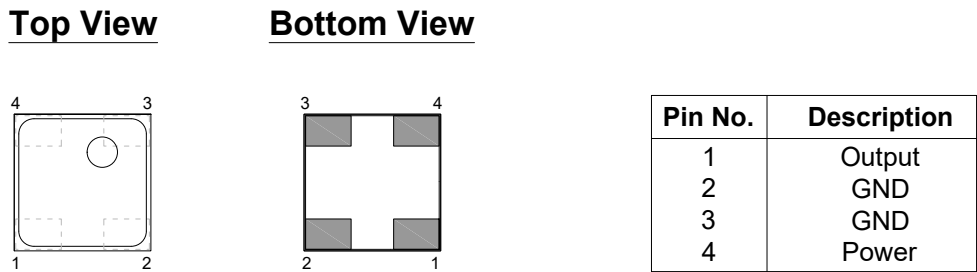


Figure 4. Electrical Layout of SMO01A-42

5.3. Terminology

- 5.3.1.** Pin 1: The Output Terminal, where the analog signal equivalent to applied pressure is available.
- 5.3.2.** Pin 2, 3: The Terminal where the supply negative is connected to sensor package.
- 5.3.3.** Pin 4: Input Voltage (maximum 3.6V).
- 5.3.4.** Sensitivity: Sensitivity is the open circuit output voltage amplitude for a given sound pressure at the pressure sensor diaphragm. This is frequency dependent so typically quoted at 1KHz. Units are defined in dB logarithmic scale. It is measured at the following conditions, $f = P_{IN} = 1Pa$, $V_{DD} = 2.1V$.

6. Component Requirement (All data taken at 25°C unless otherwise specified)

6.1. General Requirement

- 6.1.1.** Operating Temperature Range : -40°C to +100°C
- 6.1.2.** Storage Temperature Range : -40°C to +125°C
- 6.1.3.** Solder reflow (for 30s max. of peak temperature) : $\leq 260^{\circ}\text{C}$

6.2. Electrical Requirement

- 6.2.1.** Directivity : Omnidirectional
- 6.2.2.** Maximum Input Sound Level
(for less than 5% distortion) : 120dB
- 6.2.3.** Sensitivity
(0dB = 1V/Pa, 1kHz) : $-42\text{dB} \pm 3\text{dB}$
- 6.2.4.** Operating Voltage Range : 1.5V to 3.6V
- 6.2.5.** Current Consumption : $\leq 0.2\text{mA}$
- 6.2.6.** Frequency Range : 100Hz ~ 17KHz
- 6.2.7.** Output Impedance : $\leq 300\Omega$
- 6.2.8.** Total Harmonic Distortion : $\leq 0.5\%$ (at 94dB)
- 6.2.9.** S/N Ratio : $\geq 58\text{dB}$ (Typical)
- 6.2.10.** Sensitivity Variation over Operation Range : $\leq 0.5\text{dB}$
- 6.2.11.** Power Supply Rejection
(100mVp-p square wave, 217Hz, A-weighted) : -70dB (Typical)

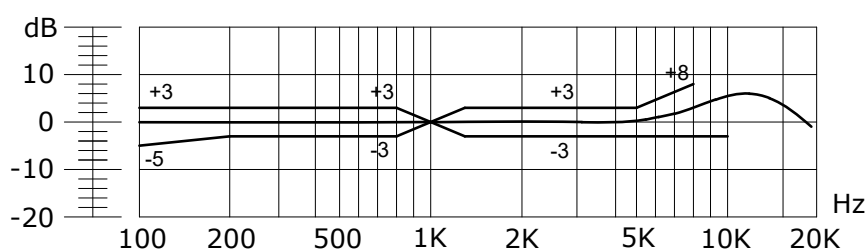


Figure 5. Frequency Response

6.3. Mechanical Requirement

- 6.3.1.** Layout and Dimension : See Section 9, Figure 8

6.4. Test Setup

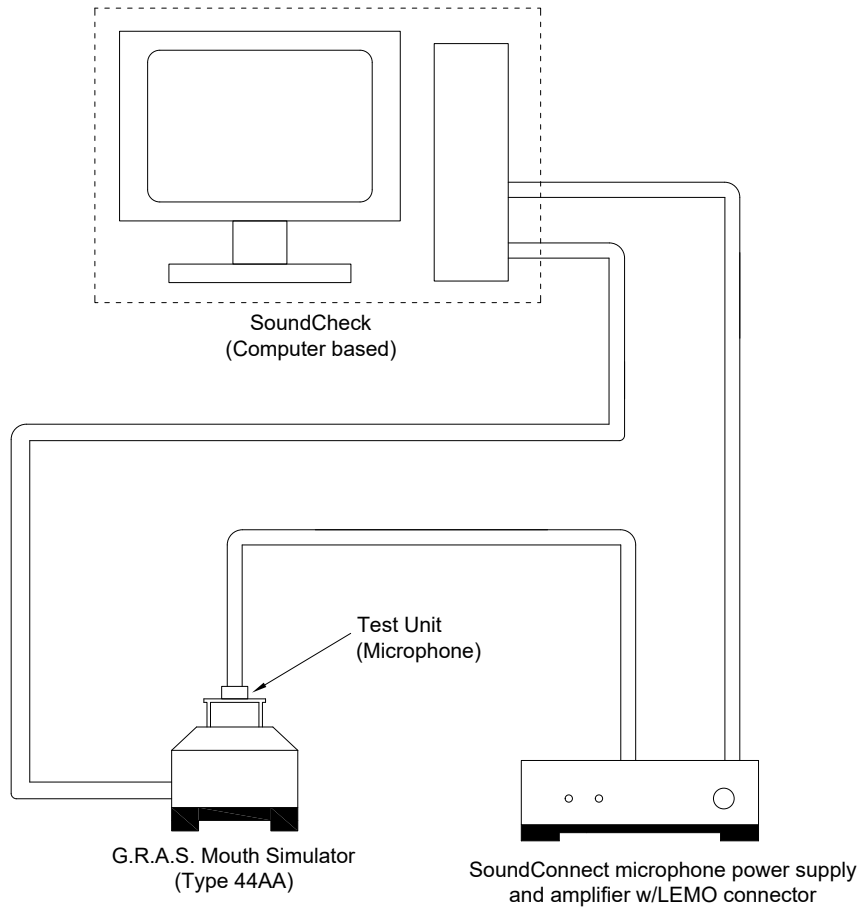


Figure 6. Test Setup

Notes : Apply sinusoidal wave from SoundCheck Audio Analyzer (Computer based) to speaker in G.R.A.S. Mouth Simulator Type 44AA. Measure sensitivity of test unit with specified driving circuit. The whole testing system should be calibrated based on calibration procedure recommended by the manufacturer before measurement. Measurement should be carried out in an excellent insulation from external noise environment.

7. Reliability Test

- 7.1. Reflow Simulation (without solder)** : Subject samples to reflow soldering condition with maximum temperature $260\pm 5^{\circ}\text{C}$ for 3 times. Components must be fully stabilized between each reflow test, which may require up to a 2 hours soak.
- 7.2. Static Humidity** : Precondition at room temperature for 1 hour. Then expose to $+85^{\circ}\text{C}$ with 85% relative humidity for 1000 hours. Finally dry at room ambient for 3 hours before taking final measurement.
- 7.3. Temperature Shock** : Each temperature cycle shall consist of 30 minutes at -40°C , 30 minutes at $+125^{\circ}\text{C}$ with 5 minutes transition time. Test duration is for 30 cycles. Components must be fully stabilized at temperature extremes before data is taken, which may require up to a 2 hours soak.
- 7.4. ESD Sensitivity** : Perform ESD sensitivity threshold measurement for each contact according to MIL-STD-883G, Method 3105.7 for Human Body Model. Identify the ESD threshold levels indicating passage of 8000V Human Body Model.
- 7.5. Random Vibration** : Vibrate randomly along three perpendicular directions for 30 minutes in each direction, 4 cycles from 20 ~ 2000Hz with a peak acceleration 20g.
- 7.6. Mechanical Shock** : Subject samples to half sine shock pulses ($3000\text{g}\pm 15\%$ for 0.3ms) in each direction, totally 18 shocks.
- 7.7. Operation Life** : Subject samples to $+125^{\circ}\text{C}$ for 168 hours under maximum input voltage.
- 7.8. Drop Test** : Drop samples naturally from the height of 1.5m onto a steel surface board for 3 times in 6 directions, totally 18 drops.

8. Recommended reflow oven temperature profile

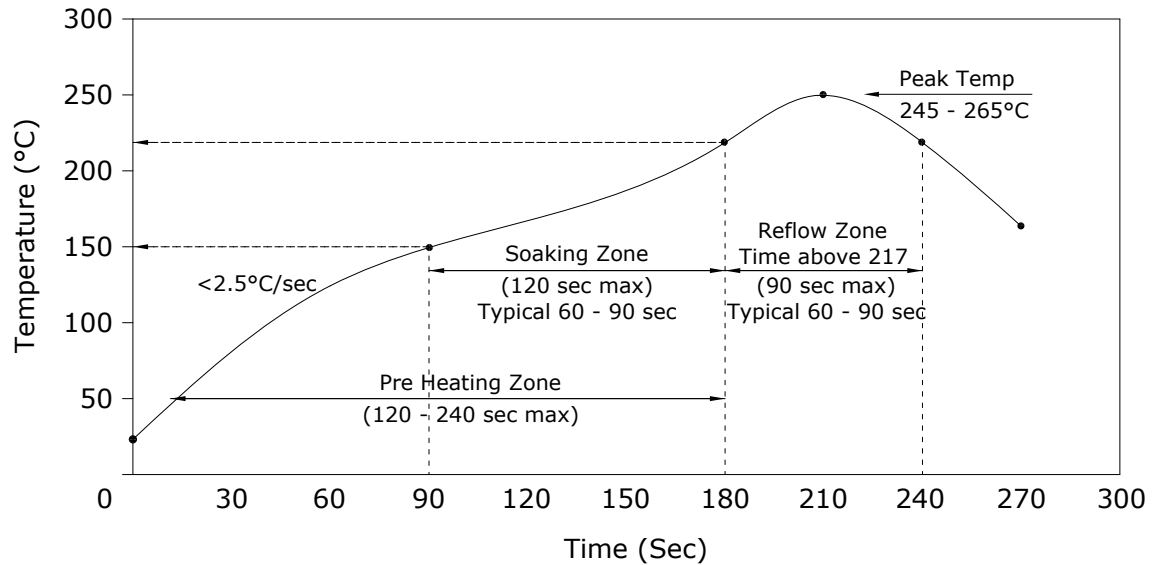


Figure 7. Recommended reflow oven temperature profile

Notes:

1. Pb-free soldering assembling processing: Reference IPC/JEDEC J-STD-020C.
2. Number of Reflows - Recommended not more than 3 cycles.
3. The SMD process should use no clean solder paste, cleaning is not allowed because washing will damage the pressure sensor sensing elements.
4. Do not board wash after the reflow process. Board washing and cleaning can damage the device.
5. Do not expose ultrasonic processing and cleaning.
6. Do not expose plasma cleaning process.

9. Mechanical Requirements

Unit : mm

Tolerance : Linear = ± 0.15
(unless otherwise specified)

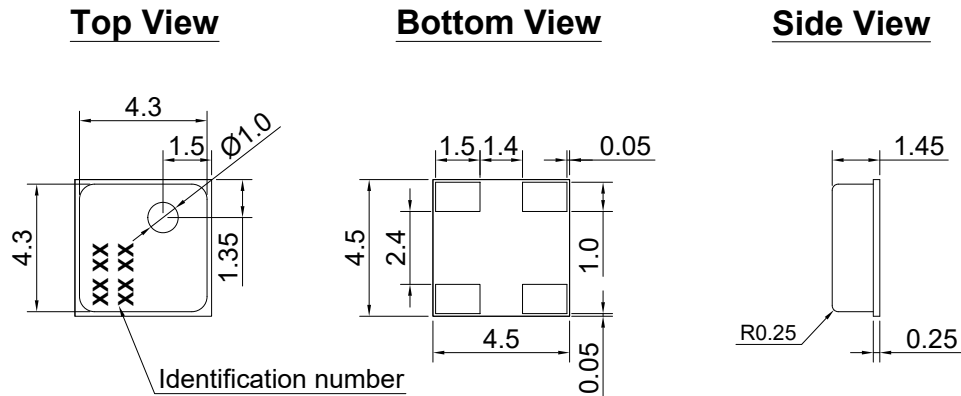


Figure 8. Mechanical Layout of SMO01A-42

10. PCB Solder Pad Layout

The below figure provide general guidance about the recommended PCB land pattern. The land pattern dimensions are exactly the same size and shape as the pads on the pressure sensor module. Recommended solder paste height is 3-5 mils (75 μ m to 125 μ m).

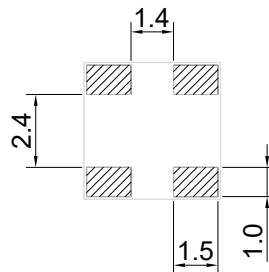


Figure 9. PCB solder pad layout for SMO01A-42

11. Standard Packing Requirements

11.1. Tape and Reel

11.1.1. Packing Options

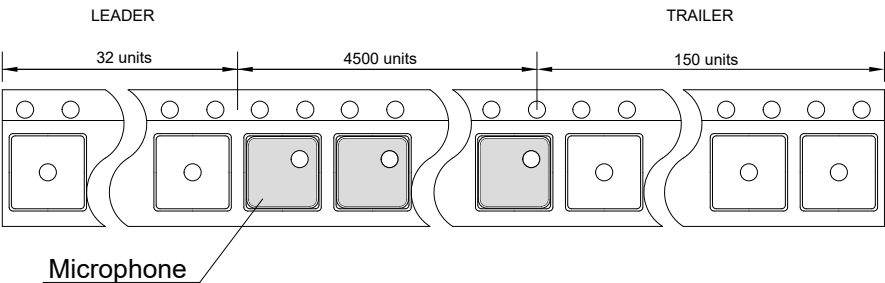


Figure 10. Tape and Reel Packing Quantity

11.1.2 Tape Layout

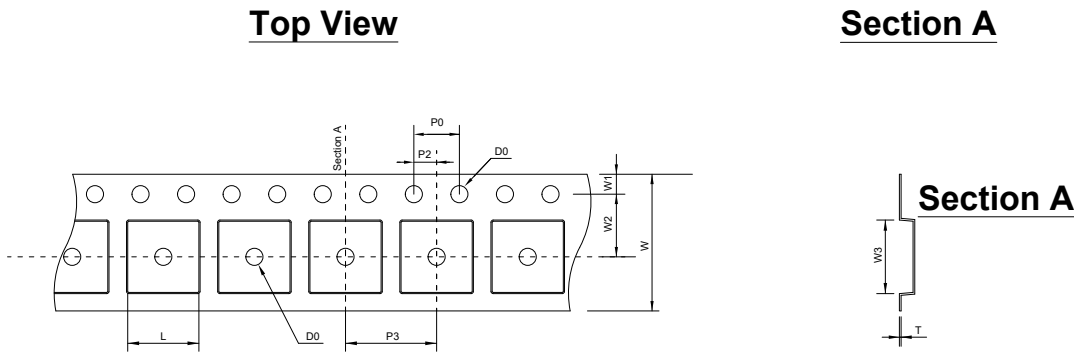


Figure 11. Tape Layout

Symbol	Millimeter		
	MINIMUM	NOMINAL	MAXIMUM
D0	1.5	1.5	1.6
P1	1.9	2.0	2.1
P2	3.9	4.0	4.1
P3	7.9	8.0	8.1
L	4.7	4.8	4.9
W	11.7	12.0	12.3
W1	1.65	1.75	1.85
W2	5.4	5.5	5.6
W3	4.7	4.8	4.9
T	0.25	0.3	0.35

11.1.3. Reel Layout

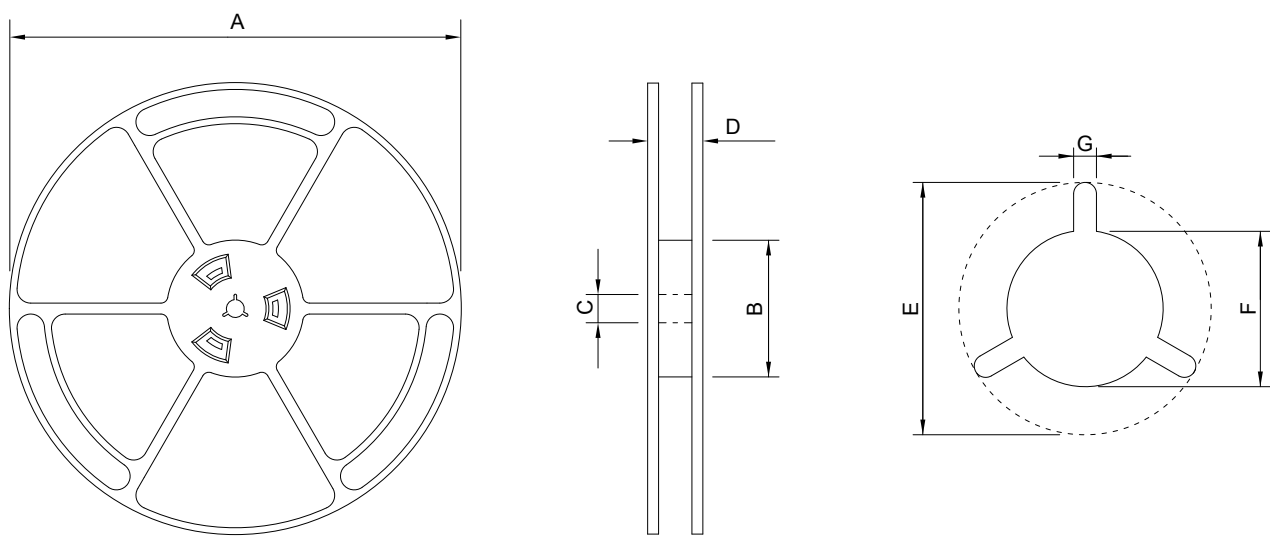


Figure 12. Reel Layout

Item	Symbols	Diameter (mm)		
		Minimum	Nominal	Maximum
Reel Diameter	A	-	330	-
Hub Diameter	B	98	100	102
Hub Hole Diameter	C	12.8	13	13.5
Reel Width (measured at Hub)	D	-	18	18.4
Arbor Hole	E	20.2	-	-
Arbor Hw in mm Diameter	F	12.8	13.0	13.5
Arbor Slot Width	G	1.5	-	-

11.1.4. Reel Installation and Carton Information

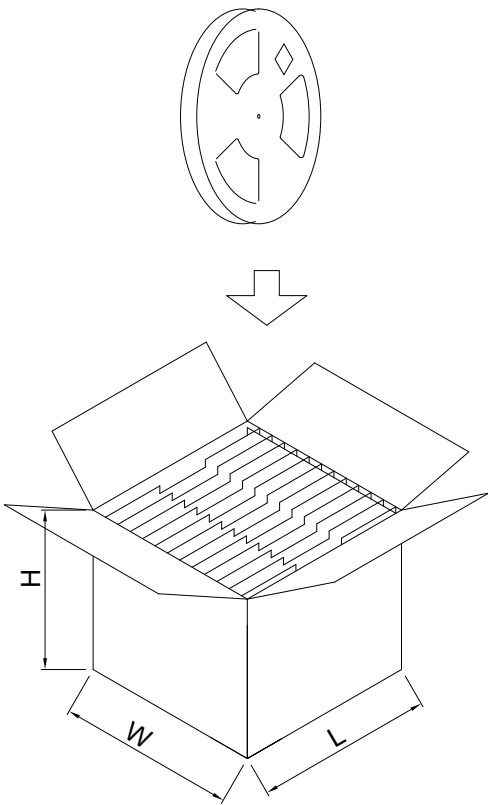
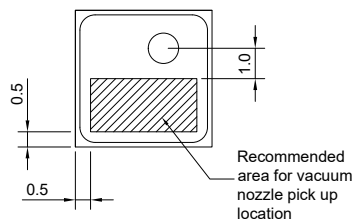


Figure 13. Reel Installation

Qty/reel (pcs)	Weight/reel (kg)	Reel/carton (nos)	Qty/carton (pcs)	Weight full load (kg)	Dimension carton box (LxWxH) mm	Storage (Temp)
4800	0.70	10	48000	~10.00	419 x 276 x 381	-10°C ~ 50°C

11.2. Pickup Tool Pick Location



Pick Up Pressure Limits		
Condition	mmHg	PSI
Max. Air Purge	3000	58
Max. Vacuum	-500	9.6

Figure 14. Packup Tool Pick Location

11.3. Label Layout

(P) Part Number: SMO01A-42

Supplier: JL World

(Q) Quantity: 4800 PCS

Figure 15. Label Layout Sample